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FOR IMMEDIATE RELEASE

**Rogers Corporation Showcases
Advanced Circuit Materials at IEEE/MTT-S IMS 2007**

ROGERS, Conn. – May 22, 2007 – Rogers Corporation (NYSE:ROG) will showcase several advanced circuit materials at the IEEE MTT-S International Microwave Symposium 2007 in Honolulu, Hawaii, June 5-7 (Booth #843). These products are used in a wide range of high frequency applications, including the advanced packaging, antenna and power amplifier markets.

As a pioneer in the advanced circuit materials field, Rogers Corporation has helped shape the high frequency marketplace by developing innovative products such as the RT/duroid®5000 series, RT/duroid® 6002, RO3000®, RO4000® and TMM® laminates. Rogers Corporation also has global resources with offices located in Europe and the United States, as well as a strong presence in the Asia Pacific with facilities in China, Singapore, Japan, Korea and Taiwan.

Products that Rogers Corporation will display at IEEE/MTT-S IMS 2007 include:

Advanced Packaging Materials

- **Thermoset Materials:** Products such as RO4350B™, RO4450B™ RO4450D™ laminates offer low moisture absorption and low loss, as well as FR4 and lead-free multi-layer processing capabilities. They are also available in .004”-.060” thicknesses.
- **Thermoplastic Materials:** The RO2800® and ULTRALAM® 3000 materials are available in thin dielectric layers (.001”-.004”) and exhibit low loss and low moisture absorption. They also are lead-free, making them environmentally friendly.

New Enhanced Copper Bond Technology

- This low profile copper technology provides tighter trace width tolerances, lower insertion loss and improved passive intermodulation at high operating frequencies.

Antenna Grade Materials

- These wide range of antenna grade materials exhibit losses as low as .0013 and PIM values better than -155 dBc. A variety of options including thick dielectric grades and high Dk are also available.

About Rogers Corporation

Rogers Corporation (NYSE:ROG), headquartered in Rogers, Conn., is a global technology leader in the development and manufacture of high performance, specialty-material-based products for a variety of applications in diverse markets including: portable communications, communications infrastructure, computer and office equipment, consumer products, ground transportation, aerospace and defense. Rogers operates manufacturing facilities in the United States (Arizona, Connecticut, Illinois), Europe (Ghent, Belgium) and Asia (Suzhou, China, and Hwasung City, Korea). In Asia the company maintains sales offices in Japan, China, Taiwan, Korea and Singapore. Rogers has joint ventures in Japan and China with INOAC Corporation, in Taiwan with Chang Chun Plastics and in the U.S. with Mitsui Chemicals. The world runs better with Rogers.® www.rogerscorporation.com.

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